

TYA-Low Profile High Current SMT Power Inductor

TYA4012 Series

FEATURES AND APPLICATIONS

Laird TYA series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics, industrial and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and wire wound construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

FEATURES

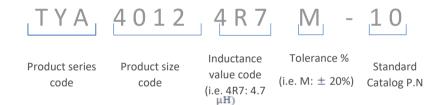
- Magnetic shielded structure
- · Low DCR and high efficiency
- Low profile and small size
- Metal alloy core with high saturation

APPLICATIONS

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



PART NUMBER EXPLANATION



ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 1MHz, 1.0Vrms
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 70%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air. The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



3.EQUIVALENT CIRCUIT:

Laird Performance Materials

Shielded Power Inductor

TYA4012 Series Rev: A www.laird.com **SPECIFICATION** 1.MECHANICAL & DIMENSIONS (UNIT: mm) 4.00±0.30 Α В 4.00±0.30 С 1.30 Max ш D 3.30±0.30 Е 1.20 REF മ F 1.60 REF G 3.70 REF 1.60 REF Н I 1.30 REF **REMARK** 2.PART NUMBER NOMENCLATOR: D: Inductance Tolerance. (M=±20%, N=±30%) TYA 4012 3R3 M - 10 E: "X"=0:Standard catalog part number D Α В "X"=1-9:Controlled customized part **Or** different A: Product Series. performance than std catalog part. B: Series number, part size C: Inductance code



Shielded Power Inductor

			www.laird.com	TYA4012 Sei	ries Rev: A	
SPECIFICATI	ON					
PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Typ	DCR(mΩ) Max	
TYA4012R47M-10	0.47	3.80	7.20	33.00	41.00	
TYA4012R56M-10	0.56	3.20	6.00	40.00	50.00	
TYA4012R68M-10	0.68	3.25	5.20	42.00	55.00	
TYA40121R0M-10	1.00	3.00	3.80	49.00	59.00	
TYA40121R5M-10	1.50	2.80	3.80	60.00	75.00	
TYA40122R2M-10	2.20	2.50	2.80	75.00	90.00	
TYA40123R3M-10	3.30	2.00	2.80	106.00	130.00	
TYA40124R7M-10	4.70	1.80	2.30	145.00	175.00	
TYA40126R8M-10	6.80	1.50	1.60	190.00	230.00	
TYA40128R2M-10	8.20	1.46	1.58	210.00	273.00	
TYA4012100M-10	10.00	0.85	1.55	300.00	360.00	
TYA4012220M-10	22.00	0.80	1.00	650.00	800.00	
GENERAL SPECI	FICATION:					
I, Test conditions(L)	: 1.0MHz, 1Vrms					
2, Operating temperating	ature: -40°C to +12	25℃(Including s	elf-heating)			
3, Storage temperat	ure: -10℃ to +40℃					
1, Humidity range: 7	0% RH Max.					
5, Heat Rated Curre	nt (Irms) will cause	the coil temper	ature rise approxim	ately ∆t of 40°C		
6, Saturation Curren	t (Isat) will cause L	.0 to drop appro	ximately 30%.			
7, Part Temperature	(Ambient+Temp.	Rise) : Should n	ot exceed 125°C ur	der worst case	conditions.	
3, Storage condition	(component in its	packaging)				

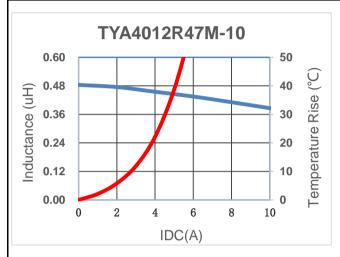


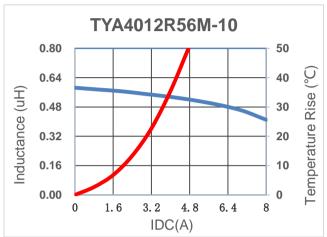
Shielded Power Inductor

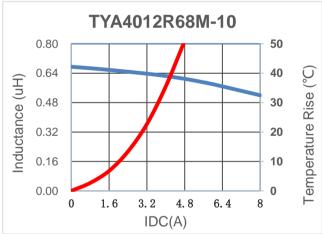
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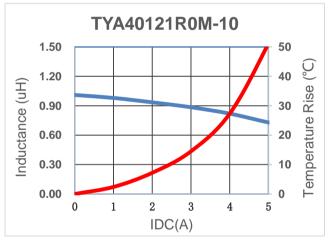
SPECIFICATION

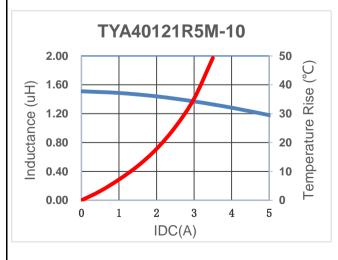
Characteristics Curve

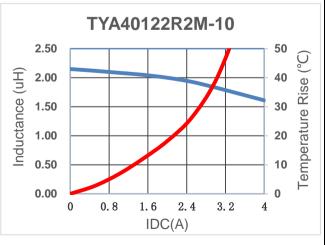














Shielded Power Inductor

TYA4012 Series www.laird.com Rev: A **SPECIFICATION Characteristics Curve** TYA40123R3M-10 TYA40124R7M-10 4.00 50 6.00 50 3.20 4.80 40 nductance (uH) Inductance (uH) **Temperature Rise** 30 3.60 2.40 30 Temperature 1.60 20 2.40 20 0.80 1.20 10 0.00 0.00 0 0 0.8 1.6 2.4 3. 2 0.6 1.2 1.8 2.4 IDC(A) IDC(A) TYA40128R2M-10 TYA40126R8M-10 10.00 50 8.00 50 Temperature Rise (°C) (Hn) e.00 6.00 4.00 2.00 40 6.40 Inductance (uH) Temperature Rise 30 30 4.80 20 20 3.20 2.00 1.60 0.00 0 0.00 0 0.6 1.2 1.8 3 0.6 1.2 1.8 2.4 IDC(A) IDC(A) TYA4012100M-10 TYA4012220M-10 25.00 50 50 12.00 Temperature Rise (°C) (20.00) 15.00 10.00 5.00 9.60 7.20 4.80 2.40 40 30 Temperature 20 10 0.00 0.00 0 0 0.6 3 1.2 1.8 2.4 0.5 1.5 1 IDC(A) IDC(A)



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Recommended Soldering Conditions

For Lead-Free Application Figure 1. Re-flow Soldering RECOMMENDED SOLDERING CONDITIONS 255°C MAX:255°C 240°C 190°C 290±30sec Gradual Cooling



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Reliability and Testing Conditions / Pin Type Power Inductors SMD series(Consumer) Reference **Additional Requirements** Item Operating temperature -40°C ~ +125°C (Including self-temperature rise) range Storage temperature -10°C to +40°C , 70% RH Max and humidity range High Temperature MIL-STD-202 Method 108 Exposure 85±2°C, 168+24hours (Storage) Temperature Cycling JESD22 Method JA-104 -40°C→+85, transforming interval:20s, 100cycles 85±°C, 168+24hours MIL-PRF-2 Operational Life Apply maximum rated voltage and current according part drawing Inspect device construction, marking and workmanship. Electrical External Visual MIL-STD-883 Method 2009 Test not required. Verify physical dimensions to the applicable device detail **Physical Dimension** JESD22 Method JB-100 specification. Note: User(s) and Suppliers spec. Electrical Test not required 10~55Hz.1.5mm. MIL-STD-202 2 hours in each 3mutually Vibration perpendicular directions Method 204 (total of 6 hours) Resistance to Soldering MIL-STD-202 1. Max. 260±5°C,10±1s, 2 times Method 210 Heat 2.Solder Composition: Sn/3Ag/0.5Cu Solderability J-STD-002 245±5°C, 5±1sec, Solder: Sn/3.0Ag/0.5Cu Parametrically test per lot and sample size requirements, Electrical Print Spec summary to show Min, Max, Mean and Standard deviation at Characterization room as well as Min and Max Operating temperatures **Board Flex** AEC-Q200-005 2mm,30±1s Terminal Strength(SMD) AEC-Q200-006 10N, 5S, X,Y direct

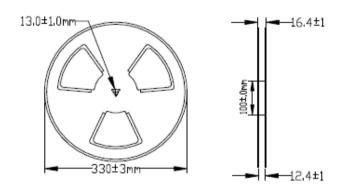


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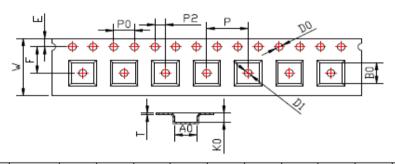
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PACKAGING

Reel Dimension



Tape Dimension

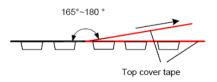


ITEM	w	A0	В0	K0	Р	F	E	D0	D1	P0	P2	Т
DIM	12.00	4.3	4.3	1.6	8.00	5.50	1.75	1.50	1.50	4.00	2.00	0.30
TOLE	+0.30 -0.10	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	+0.1	+0.1	±0.1	±0.1	±0.05

Packaging Quantity

P/N	Chip/Reel	Inner Box	Outer Box
TYA4012 series	4500pcs	9000pcs	18000pcs
Size		-	-

Peeling Off Force



The force peeling off cove tape is 10 to 100 grams							
in the arrow direction under the following conditions							
Room	Room Humidity	Room atrn	Teaming Speed				
Temp	(%)	(hPa)	(mm/min)				
5~35	45~85	860~1060	300				

- **XStorage Conditions**1. Temperature and humidity conditions: -10-+40℃ and 70% RH.
- 2. Recommended products should be used within 12 months from the time of manufacturing.
- 3. The packaging material should be kept where no chlorine or sulfur exists in the air.
- 4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking